APPLICABLE STANDARD

71 1 107	DEE O I AIVI	טאואט										
	VOLTAGE		150V AC			CURRENT			1A			
	OPERATING TEMPERATURE RANGE		-35°C TO + 85°C(NOTE 1)		1	RAGE			-10°C TO + 60°C(N		3)	
RATING	OPERATING		,		sто	PERATURE RANGE RAGE		-			-,	
	HUMIDITY RANGE APPLICABLE		20% TO 80% (NOTE 2)			HUMIDITY RANGE APPLAICABLE			20% TO 70% (NOTE 3			
	CONNECTOR	DF13- * S-1. 25C			CRIMP CONTACT			DF13-2630SCF, DF13-30		SCF		
			SPEC	IFICA	ATIO	NS_						
	ΓEM	TEST METHOD				REQUIREMENTS				QT	AT	
	RUCTION	Ivacua i i s	AND DV ME COUDING INCTOL	IN ACT IT		140001	DINO T	- DD	AMMINIO	1	Lv	
GENERAL EXAMINATION MARKING		VISUALLY AND BY MEASURING INSTRUMENT. CONFIRMED VISUALLY.				ACCORDING TO DRAWING.				X	X	
										Х	X	
	IC CHARA					30m(MAY				_	
CONTACT RESISTANCE		100m A (DC OR 1000 Hz).				30mΩ MAX.				X	-	
INSULATION RESISTANCE		100V DC.				500MΩ MIN.				X	_	
VOLTAGE PROOF		500V AC FOR 1 min.				NO FLASHOVER OR BREAKDOWN.				+	<u> </u>	
MECHAN	NICAL CHA	RACTI	FRISTICS							1^		
MECHANIC.			ES INSERTIONS AND EXT	RACTION	1S.	① COI	NTACT R	ESIS	TANCE: 30mΩ MAX		I	
OPERATION						② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				X	_	
VIBRATION		FREQUENCY 10 TO 55 Hz, SINGLE AMPLITUDE 0.75 mm, AT 2 h, FOR 3 DIRECTIONS.				NO ELECTRICAL DISCONTINUITY OF 1µs. NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				. X	_	
SHOCK		490 m/s ² DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.				① NO ELECTRICAL DISCONTINUITY OF 1μs. ② NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				. X	-	
ENVIRO	NMENTAL	CHAR.	ACTERISTICS			01	171110.					
RAPID CHA			RATURE -55→ 5 TO 35→+8	35→ 5 TC	0 35 °C	① CO1	NTACT RE	SIST	ANCE: 30mΩ MAX.		T	
TEMPERATURE						② INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				X	-	
DAMP HEAT		· · · · · · · · · · · · · · · · · · ·				① CONTACT RESISTANCE: 30mΩ MAX.						
(STEADY STATE)						② INSULATION RESISTANCE: 500MΩ MIN. ③ NO DAMAGE, CRACK OR LOOSENESS OF PARTS.				X	-	
RESISTANC						NO DEFORMATION OF CASE OF						
SOLDERING	3 HEAT	250±5°CMAX, FOR 3 SECONDS. 2) SOLDERING IRONS: :290±10°C, FOR 3 SECONDS				EXCESSIVE LOOSENESS OF THE TERMINALS.				X	-	
SOLDERABILITY		*				SOLDER SHALL COVER A MINIMUM OF						
		215±5°C FOR INSERTION DURATION, 3 SECONDS.				95 % OF THE SURFACE BEING IMMERSED.				X	_	
NOTE 2: NO NOTE 3:APP BEF	CONDENSING. LY TO THE CO ORE PCB ON I	MPERATU NDITION C	JRE RISE BY CURRENT. OF LONG TERM STORAGE TER PCBBOARD, OPERATI D FOR INTERM STORAGE D	FOR UNU: NG TEMP	ERATUF	ODUCT:	S					
COUN	T DE	SCRIPTION OF REVISIONS			DESIG	NED			CHECKED		λΤΕ	
Unless otherwise specifid , r			fer to JIS C 5402.				APPRO\	/ED	ED TY.OMA		06.09.25	
	•	•					CHECKED		HK.UMEHARA	06.09.2		
							DESIGN	ED			09.25	
						DRAWN		'N	AK.MIURA	06.09.21		
Note QT:Qualification Test AT:Assurance Test X:Applicable Test					DF	RAWING NO.			ELC4-162420-03			
HS.	SI	PECIFICATION SHEET			PART NO.		DF13-*P-1. 25DS (20)			1		
HIROSE E			ECTRIC CO., LTD.		CODE NO.		CL536		CL536	Δ	1/1	
EODM UD0011 C 1												